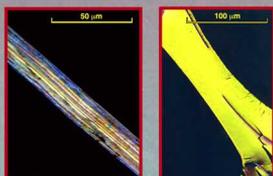
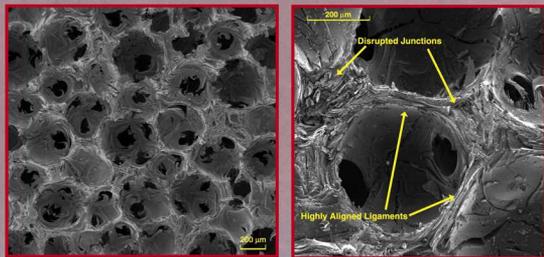


Carbon Foam for Thermal Management of Fuel Cells

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Physical Properties



DKD-x® Fiber
2800°C
k ~ 600 W/m-K

ORNL Graphite Foam
2800°C
k ~ 1700 W/m-K

| Material | Density | Thermal Conductivity |
|------------------------|----------------------|----------------------|
| | (g/cm ³) | (W/m-K) |
| Aluminum 6061 | 2.7 | 180 |
| Copper | 8.9 | 400 |
| Carbon Fiber | 2.2 | 1000 |
| Synthetic Diamond | 2.5 | 1500 |
| Graphite Foam Ligament | 2.23 | 1700 |
| Perfect Diamond | 2.5 | 2500 |

High Thermal Conductivity with high surface area (A) will combine to yield high bulk apparent heat transfer, >180 W/m-K

Modeling Convective Heat Transfer

By modeling the convective heat transfer from the foam to fluids, engineers can begin to perform optimization design parametrization of heat exchangers and other heat transfer devices

Darcy-Forchheimer Equation for flow through porous media

$$0 = -\nabla p - \frac{\mu}{k} \mathbf{v} + \frac{H D}{\sqrt{k}} |\mathbf{v}| \mathbf{v}$$

Equation of Continuity

$$0 = \nabla \cdot \mathbf{v} - \left(\frac{\mu}{k} - \frac{H D}{\sqrt{k}} |\mathbf{v}| \right) (\nabla \cdot \mathbf{v})$$

Heat Equation in Fluid

$$0 = \nabla \cdot (-k \nabla T_w) - \rho C_p D T + \dot{q}_{\text{inlet}}$$

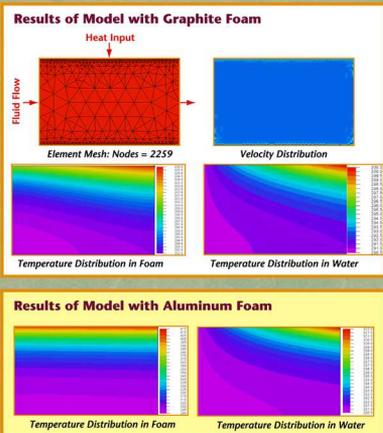
Heat Equation in Foam

$$0 = \nabla \cdot (-k \nabla T_f) - \dot{q}_{\text{loss}}$$

Model heat transfer from foam to fluid as a source/loss term: \dot{q}

$$\dot{q}_{\text{loss}} = \dot{q}_{\text{inlet}} = -h_{\text{loc}} A_{\text{spec}} (T_f - T_w)$$

- Note: All values are localized values
- Method:
- Use Finite Element Modeling to simulate a model "Flow-through" heat sink as described above
 - FlexPDE, a FEM program for the PC
 - Compare results to measured results from experiments



| Power Input | Water Flow Rate (gph) | Pressure Drop (psi) | Measured Base Plate Temperature (°C) | Predicted Base Plate Temperature (°C) | Measured Outlet Water Temperature (°C) | Predicted Outlet Water Temperature (°C) |
|-------------|-----------------------|---------------------|--------------------------------------|---------------------------------------|--|---|
| 300 W | 25 | 3.5 | 300.3 | 299.6 | 293.8 | 293.7 |
| 300 W | 45 | 7.0 | 296.8 | 297.2 | 292.6 | 292.4 |
| 600 W | 25 | 3.5 | 308.7 | 308.4 | 296.3 | 295.8 |
| 600 W | 45 | 7.0 | 303.4 | 303.6 | 293.9 | 293.9 |

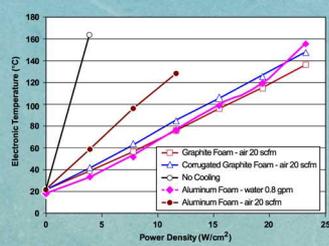
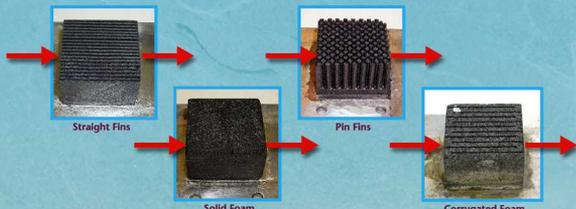
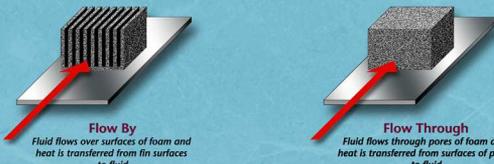
- Results:
- FEM modeling can predict convective heat transfer from foam to fluid flowing through pores
 - Model needs to be expanded to predict convective heat transfer from finned foam structure to a fluid
 - Model needs to be expanded to predict heat transfer from foam to a boiling liquid to simulate evaporative cooling systems (humidification)

Conclusions

- Engineering solutions, such as corrugation, can be found to overcome some of the deficiencies of the foam to dramatically reduce pressure drop
- Modeling of convective heat transfer for fluid flowing through foam has been successful. Further work is needed to extend this to other engineering problems with foam
- There are many other areas of interest that have developed in utilizing the graphite foam, such as catalyst supports, interconnects, and membrane supports

Power Electronics

Miniaturization of power electronics often results in overheating and failure of these circuits. Compact heat sinks are being developed to dissipate the waste heat more efficiently



| Heat Sink | Pressure Drop (psi/in) |
|--------------------------|------------------------|
| Aluminum Foam | 0.06 |
| Graphite Foam | 2.42 |
| Corrugated Graphite Foam | 0.17 |

- Solid graphite foam has very high pressure drops
- Corrugated graphite foams can reduce pressure drop dramatically (almost to that of aluminum foams)
- Graphite foams can remove as much heat with air as aluminum foam can with water

Other Research of Foams for Fuel Cells

- Use of the foam as an evaporative cooling medium
- Use of the foam to provide simultaneous humidification and electronics cooling has been demonstrated
 - Demonstrated power dissipation rates of up to 100 W/cm²
 - Currently working with NSA to further develop this technology

- Significant research into joining and characterization
- Special solders and brazes have recently been developed
 - Corrosion, fouling, vibration, and durability characteristics are being examined

- Use of foam for interconnects/bipolar plates
- Electrical conductivity is extremely high, >700 S/cm in plane
 - Spongy nature of foam prevents brittleness found in other graphite interconnects
 - Coatings with chromium and other metals to protect from oxidation
 - Can be used as the substrate for the membrane
 - Both solid oxide and PEM fuel cells

- Use of the foams for catalyst support for low temperature cracking of ammonia
- Supplying pure hydrogen for fuel
 - Recover waste heat, catalyze reaction, and improve efficiency of fuel cell

- Coatings for protection from oxidation and corrosion
- Silicon Carbide vapor deposition
 - Chromium depositing technique (packed cementation)
 - This technique can be used to deposit other materials on to the surfaces of the foam

